

Docket No.: 9533.004.00

Declaration, Power of Attorney and Petition

WE (I) the undersigned inventor(s), hereby declare(s) that:

My residence, post office address and citizenship are as stated below next to my name,

We (I) believe that we are (I am) the original, first, and joint (sole) inventor(s) of the subject matter which is claimed and for which a patent is sought on the invention entitled

COPPER FOUNDATION MEMBRANE FORMATION MATERIAL

the specification of which

	is attached hereto.			
×	was filed on	December 11, 2003		
	•	as Application No.	10/732,812	
		and amended on		
	was filed as PCT international application			
	Number			
	on			
and was amended under PCT Article 19				
· -	on		(if applicable).	

- We (I) hereby state that we (I) have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.
- We (I) acknowledge the duty to disclose information known to be material to the patentability of this application as defined in Section 1.56 of Title 37 Code of Federal Regulations.
- We (I) hereby claim foreign priority benefits under 35 U.S.C. §119(a)-(d) or §365(b) of any foreign application(s) for patent or inventor's certificate, or §365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed. Prior Foreign Application(s)

Application No.	Country	Day/Month/Year	Priority Claimed			
542036JP01	Japan	12 December 2002	×	Yes 🗆		No
				Yes		No
				Yes		No
				Yes		No

We (I) hereby claim the benefit under Title 35, United States Code, §119(e) of any United States provisional application(s) listed below.

10/ 1732.812	Pecember 11. 2003			
(Application Number)	(Filing Date)			

We (I) hereby claim the benefit under 35 U.S.C. §120 of any United States application(s), or §365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. §112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR §1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.

Application Serial No.	Filing Date		Status (pending, patented, abandoned)

And we (I) hereby appoint Song K. Jung, Reg. No. 35,210; Matthew T. Bailey, Reg. No. 33,829; Rebecca Goldman Rudich, Reg. No. 41,786; Eric J. Nuss, Reg. No. 40,106; Anthony J. Josephson, Reg. No. 45,742; George Ballas, Reg. No. 52,587; Valerie P. Hayes, Reg. No. 53,005; Mark Kresloff, Reg. No. 42,766; and Kurt M. Eaton, Reg. No. 51,640 as our (my) attorneys, with full powers of substitution and revocation, to prosecute this application and to transact all business in the Patent Office connected therewith; and we (I) hereby request that all correspondence regarding this application be sent to Song K. Jung of McKenna Long & Aldridge LLP, Attorneys At Law, 1900 K Street, N.W., Washington, D.C. 20006.

We (I) declare that all statements made herein of our (my) own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Hideaki MACHIDA	Residence: 8154-217 Venohara, Venohara mach					
NAME OF FIRST INVENTOR	Kitatsuru- fun, Pamanashi, 409-0112					
Hideak: Machida	Citizen of: Japanese.					
Signature of Inventor	Post Office Address: Same As Above					
June . 1 . 2004						
Date						